



### **Features**

- Fast Switching Speed
- Ultra-Small Surface Mount Package
- Low Reverse Leakage Current
- Ideal for Battery Powered Portable Applications
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

### **Mechanical Data**

- Case: X1-DFN1006-2
- Case Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0

SURFACE MOUNT FAST SWITCHING DIODE

- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Marking Information
- Terminals: Finish—NiPdAu over Copper Leadframe; Solderable per MIL-STD-202, Method 208 @4
- Weight: 0.001 grams (Approximate)

X1-DFN1006-2



Bottom View



**Device Schematic** 

### Ordering Information (Note 4)

Notes:

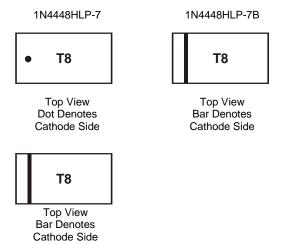
Part Number	Case	Packaging
1N4448HLP-7	X1-DFN1006-2	3000/Tape & Reel
1N4448HLP-7B	X1-DFN1006-2	10,000/Tape & Reel

No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</p>

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

# Marking Information (Note 5)



T8 = Product Type Marking Code

Note: 5. From date code 1527 (YYWW), dot marking was changed to bar marking for 1N4448HLP-7.



# Maximum Ratings (@T<sub>A</sub> = +25°C unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage		V <sub>RM</sub>	100	V
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V <sub>RRM</sub> V <sub>RWM</sub> V <sub>R</sub>	80	V
RMS Reverse Voltage		V <sub>R(RMS)</sub>	57	V
Forward Continuous Current		I <sub>FM</sub>	300	mA
Average Rectified Output Current		lo	95	mA
1 0	@ t = 1.0µs @ t = 1.0s	I <sub>FSM</sub>	2.0 1.0	А

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	PD	250	mW
Thermal Resistance Junction to Ambient (Note 6)	R <sub>ÐJA</sub>	500	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-65 to +150	°C

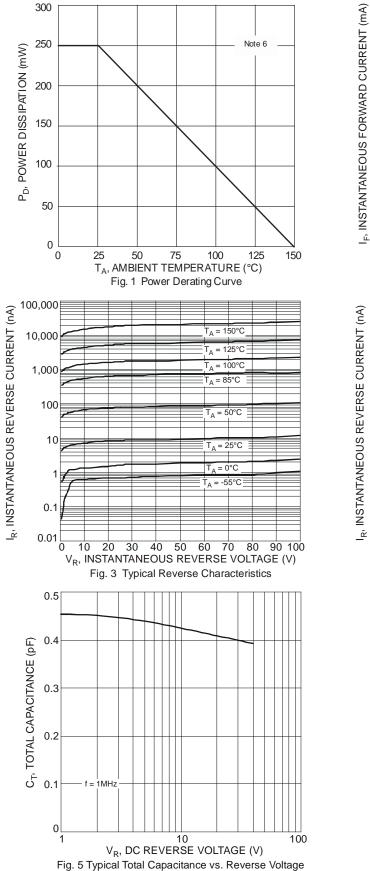
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

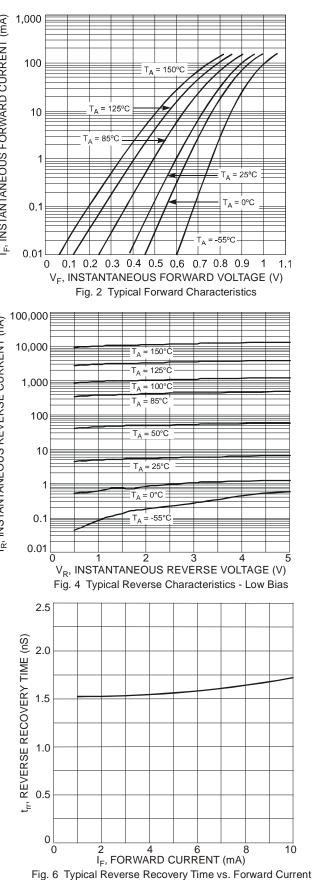
Characteristic	Symbol	Min	Max	Unit	Test Conditions
Reverse Breakdown Voltage (Note 7)	V <sub>(BR)R</sub>	80	_	V	I <sub>R</sub> = 100μA
	VF	0.62	0.72	V	$I_F = 5.0 \text{mA}$
Forward Voltage		—	0.855		$I_F = 10 \text{mA}$
orward voltage		—	1.0		I <sub>F</sub> = 100mA
		_	1.25		I <sub>F</sub> = 150mA
			100	nA	V <sub>R</sub> = 80V
Peak Reverse Current (Note 7)	1-		50	μA	V <sub>R</sub> = 75V, T <sub>J</sub> = +150°C
Peak Reverse Current (Note 7)	IR	_	30	μA	V <sub>R</sub> = 25V, T <sub>J</sub> = +150°C
			25	nA	$V_R = 20V$
Total Capacitance	CT	_	3.0	pF	$V_{R} = 0.5V, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>		4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

Part mounted on FR-4 PC board with recommended pad layout, which can be found on our website at http://www.diodes.com.
Short duration pulse test used to minimize self-heating effect.

Notes:



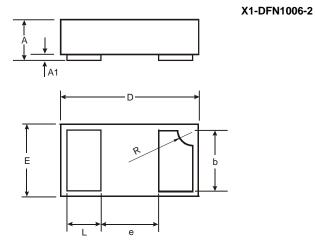






# **Package Outline Dimensions**

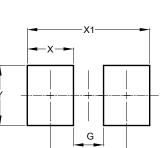
Please see http://www.diodes.com/package-outlines.html for the latest version.



X1-DFN1006-2					
Dim	Min	Max	Тур		
Α	0.47	0.53	0.50		
A1	0	0.05	0.03		
b	0.45	0.55	0.50		
D	0.95	1.075	1.00		
Е	0.55	0.675	0.60		
е	1	-	0.40		
L	0.20	0.30	0.25		
R	0.05	0.15	0.10		
All Dimensions in mm					

# **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



C

Dimensions	Value (in mm)		
С	0.70		
G	0.30		
Х	0.40		
X1	1.10		
Y	0.70		

X1-DFN1006-2



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